



SLOVENSKI STANDARD

SIST-TP IEC/TR 61000-3-6:2016

01-maj-2016

Nadomešča:

SIST-TP IEC/TR3 61000-3-6:2004

Elektromagnetna združljivost (EMC) - 3-6. del: Mejne vrednosti - Ocena oddajnih mej za priklop motečih naprav v SN, VN in EVN elektroenergetska omrežja

Electromagnetic compatibility (EMC) - Part 3-6: Limits - Assessment of emission limits for the connection of distorting installations to MV, HV and EHV power systems

iTeh STANDARD PREVIEW
(standards.iteh.ai)

[SIST-TP IEC/TR 61000-3-6:2016](https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-2025/sist-tp-61000-3-6)

[https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-](https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-2025/sist-tp-61000-3-6)

Ta slovenski standard je istoveten z IEC/TR 61000-3-6

ICS:

33.100.10

Emisija

Emission

SIST-TP IEC/TR 61000-3-6:2016

en

iTeh STANDARD PREVIEW
(standards.iteh.ai)

[SIST-TP IEC/TR 61000-3-6:2016](https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-bf0d68e415a6/sist-tp-iec-tr-61000-3-6-2016)

<https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-bf0d68e415a6/sist-tp-iec-tr-61000-3-6-2016>



TECHNICAL REPORT

BASIC EMC PUBLICATION

**Electromagnetic compatibility (EMC) –
Part 3-6: Limits – Assessment of emission limits for the connection of distorting
installations to MV, HV and EHV power systems**

[SIST-TP IEC/TR 61000-3-6:2016](https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-bf0d68e415a6/sist-tp-iec-tr-61000-3-6-2016)

<https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-bf0d68e415a6/sist-tp-iec-tr-61000-3-6-2016>

INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

PRICE CODE
CODE PRIX

XA

CONTENTS

FOREWORD.....	4
INTRODUCTION.....	6
ACKNOWLEDGMENT.....	7
1 Scope.....	8
2 Normative references	9
3 Terms and definitions	9
4 Basic EMC concepts related to harmonic distortion	13
4.1 Compatibility levels	13
4.2 Planning levels.....	14
4.3 Illustration of EMC concepts.....	16
4.4 Emission levels	17
5 General principles	18
5.1 Stage 1: simplified evaluation of disturbance emission	18
5.2 Stage 2: emission limits relative to actual system characteristics.....	19
5.3 Stage 3: acceptance of higher emission levels on a conditional basis.....	19
5.4 Responsibilities	19
6 General guidelines for the assessment of emission levels	20
6.1 Point of evaluation.....	20
6.2 Definition of harmonic emission level.....	20
6.3 Assessment of harmonic emission levels.....	21
6.4 System harmonic impedance.....	22
7 General summation law	24
8 Emission limits for distorting installations connected to MV systems.....	25
8.1 Stage 1: simplified evaluation of disturbance emission	25
8.2 Stage 2: emission limits relative to actual system characteristics.....	27
8.3 Stage 3: acceptance of higher emission levels on a conditional basis.....	31
8.4 Summary diagram of the evaluation procedure	32
9 Emission limits for distorting installations connected to HV-EHV systems	33
9.1 Stage 1: simplified evaluation of disturbance emission	33
9.2 Stage 2: emission limits relative to actual system characteristics.....	33
9.3 Stage 3: acceptance of higher emission levels on a conditional basis.....	36
10 Interharmonics	36
Annex A (informative) Envelope of the maximum expected impedance	38
Annex B (informative) Guidance for allocating planning levels and emission levels at MV	39
Annex C (informative) Example of calculation of global MV+LV contribution	45
Annex D (informative) Method for sharing planning levels and allocating emission limits in meshed HV – EHV systems	46
Annex E (informative) List of symbols and subscripts.....	54
Bibliography.....	57

Figure 1 – Illustration of basic voltage quality concepts with time/ location statistics covering the whole system	17
Figure 2 – Illustration of basic voltage quality concepts with time statistics relevant to one site within the whole system	17
Figure 3 – Illustration of the emission vector U_{hi} and its contribution to the measured harmonic vector at the point of evaluation	20
Figure 4 – Example of a system for sharing global contributions at MV	28
Figure 5 – Diagram of evaluation procedure at MV	32
Figure 6 – Determination of S_t for a simple HV or EHV system	33
Figure 7 – Allocation of planning level to a substation in HV-EHV system	34
Figure A.1 – Example of maximum impedance curve for a 11 kV system	38
Figure B.1 – Example of an MV distribution system showing the MV transformer and feeders 1-6	42
Figure D.1 – HV-EHV system considered for the connection of a new distorting installation at node 1 substation	48
Figure D.2 – Harmonic Impedance at node 1	49
Figure D.3 – Harmonic Impedance at node 5 'Uranus 150 kV', when the capacitor banks at Jupiter 150 kV are switched off	50
Table 1 – Compatibility levels for individual harmonic voltages in low and medium voltage networks (percent of fundamental component) reproduced from IEC 61000-2-2 [5] and IEC 61000-2-12 [6]	14
Table 2 – Indicative planning levels for harmonic voltages (in percent of the fundamental voltage) in MV, HV and EHV power systems	15
Table 3 – Summation exponents for harmonics (indicative values)	25
Table 4 – Weighting factors W_j for different types of harmonic producing equipments	27
Table 5 – Indicative values for some odd order harmonic current emission limits relative to the size of a customer installation	28
Table B.1 – Feeder characteristics for the system under consideration	43
Table B.2 – Determination of F and S_{x1} values for the feeders	43
Table C.1 – Acceptable global contribution G_{hMV+LV} of the MV and LV installations to the MV harmonic voltages if the transfer coefficient from the HV-EHV system is considered to be unity	45
Table D.1 – Influence coefficients K_{hj-1} between node j and node 1	49
Table D.2 – Reduction factors	51
Table D.3 – Global contributions G_{hB1} at node 1	52

INTERNATIONAL ELECTROTECHNICAL COMMISSION

ELECTROMAGNETIC COMPATIBILITY (EMC) –**Part 3-6: Limits –
Assessment of emission limits for the connection of distorting
installations to MV, HV and EHV power systems**

FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- 2) The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.
- 5) IEC provides no marking procedure to indicate its approval and cannot be rendered responsible for any equipment declared to be in conformity with an IEC Publication.
- 6) All users should ensure that they have the latest edition of this publication.
- 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
- 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

The main task of IEC technical committees is to prepare International Standards. However, a technical committee may propose the publication of a technical report when it has collected data of a different kind from that which is normally published as an International Standard, for example "state of the art".

IEC/TR 61000-3-6, which is a technical report, has been prepared by subcommittee 77A: Low frequency phenomena, of IEC technical committee 77: Electromagnetic compatibility.

This Technical Report forms Part 3-6 of IEC 61000. It has the status of a basic EMC publication in accordance with IEC Guide 107 [29]¹.

This second edition cancels and replaces the first edition published in 1996 and constitutes a technical revision.

¹ Figures in square brackets refer to the Bibliography.

This edition is significantly more streamlined than first edition, and it reflects the experiences gained in the application of the first edition. As part of this streamlining process, this second edition of IEC/TR 61000-3-6 does not address communications circuit interference. Clause 9 on this (section 10) was removed, as this did not suitably address emission limits for telephone interference. The scope has been adjusted to point out that IEC/TR 61000-3-6 does not address communications circuit interference. This edition has also been harmonised with IEC/TR 61000-3-7 [30] and IEC/TR 61000-3-13 [31].

The text of this technical report is based on the following documents:

Enquiry draft	Report on voting
77A/575/DTR	77A/637/RVC

Full information on the voting for the approval of this technical report can be found in the report on voting indicated in the above table.

A list of all parts of the IEC 61000 series, under the general title *Electromagnetic compatibility (EMC)*, can be found on the IEC website.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

INTRODUCTION

IEC 61000 is published in separate parts according to the following structure:

Part 1: General

General considerations (introduction, fundamental principles)

Definitions, terminology

Part 2: Environment

Description of the environment

Classification of the environment

Compatibility levels

Part 3: Limits

Emission limits

Immunity limits

(in so far as they do not fall under the responsibility of product committees)

Part 4: Testing and measurement techniques

Measurement techniques

Testing techniques

Part 5: Installation and mitigation guidelines

Installation guidelines

Mitigation methods and devices

[SIST-TP IEC/TR 61000-3-6:2016](https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-6f0d08e415a6/sist-tp-iec-tr-61000-3-6-2016)

<https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-6f0d08e415a6/sist-tp-iec-tr-61000-3-6-2016>

Part 6: Generic standards

Part 9: Miscellaneous

Each part is further subdivided into several parts published either as International Standards or as technical specifications or technical reports, some of which have already been published as sections. Others will be published with the part number followed by a dash and a second number identifying the subdivision (example: IEC 61000-6-1).

ACKNOWLEDGMENT

In 2002, the IEC subcommittee 77A made a request to CIGRE Study Committee C4 and CIRED Study Committee S2, to organize an appropriate technical forum (joint working group) whose main scope was to prepare, among other tasks, the revision of the technical report IEC 61000-3-6 concerning emission limits for harmonics for the connection of distorting installations to public supply systems at MV, HV and EHV.

To this effect, joint working group CIGRE C4.103/ CIRED entitled “*Emission Limits for Disturbing Installations*” was appointed in 2003. Some previous work produced by CIGRE JWG C4.07-Cired has been used as an input to the revision, in particular the planning levels and associated indices. In addition, using experience since the technical report IEC 61000-3-6 was initially published in 1996, WG C4.103 reviewed the procedure used to determine emission limits and the assessment methods used to evaluate emission levels for installations.

Subsequent endorsement of the document by IEC was the responsibility of SC 77A.

iTeh STANDARD PREVIEW
(standards.iteh.ai)

[SIST-TP IEC/TR 61000-3-6:2016](https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-bf0d68e415a6/sist-tp-iec-tr-61000-3-6-2016)

<https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-bf0d68e415a6/sist-tp-iec-tr-61000-3-6-2016>

ELECTROMAGNETIC COMPATIBILITY (EMC) –

Part 3-6: Limits – Assessment of emission limits for the connection of distorting installations to MV, HV and EHV power systems

1 Scope

This Technical Report, which is informative in its nature, provides guidance on principles which can be used as the basis for determining the requirements for the connection of distorting installations to MV, HV and EHV public power systems (LV installations are covered in other IEC documents). For the purposes of this report, a distorting installation means an installation (which may be a load or a generator) that produces harmonics and/or interharmonics. The primary objective is to provide guidance to system operators or owners on engineering practices, which will facilitate the provision of adequate service quality for all connected customers. In addressing installations, this document is not intended to replace equipment standards for emission limits.

The report addresses the allocation of the capacity of the system to absorb disturbances. It does not address how to mitigate disturbances, nor does it address how the capacity of the system can be increased.

Since the guidelines outlined in this report are necessarily based on certain simplifying assumptions, there is no guarantee that this approach will always provide the optimum solution for all harmonic situations. The recommended approach should be used with flexibility and judgment as far as engineering is concerned when applying the given assessment procedures in full or in part.

The system operator or owner is responsible for specifying requirements for the connection of distorting installations to the system. The distorting installation is to be understood as the customer's complete installation (i.e. including distorting and non-distorting parts).

Problems related to harmonics fall into two basic categories.

- Harmonic currents that are injected into the supply system by converters and harmonic sources, giving rise to harmonic voltages in the system. Both harmonic currents and resulting voltages can be considered as conducted phenomena.
- Harmonic currents that induce interference into communication systems. This phenomenon is more pronounced at higher order harmonic frequencies because of increased coupling between the circuits and because of the higher sensitivity of the communication circuits in the audible range.

This report gives guidance for the co-ordination of the harmonic voltages between different voltage levels in order to meet the compatibility levels at the point of utilisation. The recommendations in this report do not address harmonic interference phenomena in communication circuits (i.e. only the first of the above categories is addressed). These disturbances need to be addressed in terms of international directives concerning the Protection of Telecommunication Lines against Harmful Effects from Electric Power and Electrified Railway Lines, International Telecommunication Union, ITU-T Directives [1]² or in terms of locally applicable standards such as [2], [3] or [4].

² Figures in square brackets refer to the bibliography.

NOTE The boundaries between the various voltage levels may be different for different countries (see IEC 601-01-28 [32]). This report uses the following terms for system voltages:

- low voltage (LV) refers to $U_n \leq 1 \text{ kV}$;
- medium voltage (MV) refers to $1 \text{ kV} < U_n \leq 35 \text{ kV}$;
- high voltage (HV) refers to $35 \text{ kV} < U_n \leq 230 \text{ kV}$;
- extra high voltage (EHV) refers to $230 \text{ kV} < U_n$.

In the context of this report, the function of the system is more important than its nominal voltage. For example, a HV system used for distribution may be given a "planning level" which is situated between those of MV and HV systems.

2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60050(161), *International Electrotechnical Vocabulary – Chapter 161: Electromagnetic compatibility*

3 Terms and definitions

For the purposes of this document, the following definitions apply as well as the definitions in IEC 60050(161).

3.1

agreed power

value of the apparent power of the disturbing installation on which the customer and the system operator or owner agree. In the case of several points of connection, a different value may be defined for each connection point

3.2

customer

person, company or organisation that operates an installation connected to, or entitled to be connected to, a supply system by a system operator or owner

3.3

(electromagnetic) disturbance

any electromagnetic phenomenon which, by being present in the electromagnetic environment, can cause electrical equipment to depart from its intended performance

3.4

disturbance level

the amount or magnitude of an electromagnetic disturbance measured and evaluated in a specified way

3.5

distorting installation

an electrical installation as a whole (i.e. including distorting and non-distorting parts) which can cause distortion of the voltage or current into the supply system to which it is connected

NOTE For the purpose of this report, all references to distorting installations not only include linear and non-linear loads, but generating plants, and any source of non-sinusoidal current emissions such as regenerative braking systems,

3.6**electromagnetic compatibility (EMC)**

ability of an equipment or system to function satisfactorily in its electromagnetic environment without introducing intolerable electromagnetic disturbances to anything in that environment

NOTE 1 Electromagnetic compatibility is a condition of the electromagnetic environment such that, for every phenomenon, the disturbance emission level is sufficiently low and immunity levels are sufficiently high so that all devices, equipment and systems operate as intended.

NOTE 2 Electromagnetic compatibility is achieved only if emission and immunity levels are controlled such that the immunity levels of the devices, equipment and systems at any location are not exceeded by the disturbance level at that location resulting from the cumulative emissions of all sources and other factors such as circuit impedances. Conventionally, compatibility is said to exist if the probability of the departure from intended performance is sufficiently low. See Clause 4 of IEC 61000-2-1 [33].

NOTE 3 Where the context requires it, compatibility may be understood to refer to a single disturbance or class of disturbances.

NOTE 4 Electromagnetic compatibility is a term used also to describe the field of study of the adverse electromagnetic effects which devices, equipment and systems undergo from each other or from electromagnetic phenomena.

3.7**(electromagnetic) compatibility level**

specified electromagnetic disturbance level used as a reference level in a specified environment for co-ordination in the setting of emission and immunity limits

NOTE By convention, the compatibility level is chosen so that there is only a small probability (for example 5 %) that it will be exceeded by the actual disturbance level.

3.8**emission**

phenomenon by which electromagnetic energy emanates from a source of electromagnetic disturbance

[IEV 161-01-08 modified]

3.9**emission level**

level of a given electromagnetic disturbance emitted from a particular device, equipment, system or disturbing installation as a whole, assessed and measured in a specified manner

3.10**emission limit**

maximum emission level specified for a particular device, equipment, system or disturbing installation as a whole

3.11**generating plant**

any equipment that produces electricity together with any directly connected or associated equipment such as a unit transformer or converter

3.12**immunity (to a disturbance)**

ability of a device, equipment or system to perform without degradation in the presence of an electromagnetic disturbance

3.13**immunity level**

the maximum level of a given electromagnetic disturbance on a particular device, equipment or system for which it remains capable of operating with a declared degree of performance

3.14**non-linear load or equipment (see also distorting installation)**

any load or equipment that draws a non-sinusoidal current when energised by a sinusoidal voltage

3.15**normal operating conditions**

operating conditions of the system or of the disturbing installation typically including all generation variations, load variations and reactive compensation or filter states (e.g. shunt capacitor states), planned outages and arrangements during maintenance and construction work, non-ideal operating conditions and normal contingencies under which the considered system or the disturbing installation have been designed to operate

NOTE Normal system operating conditions typically exclude: conditions arising as a result of a fault or a combination of faults beyond that planned for under the system security standard, exceptional situations and unavoidable circumstances (for example: force majeure, exceptional weather conditions and other natural disasters, acts by public authorities, industrial actions), cases where system users significantly exceed their emission limits or do not comply with the connection requirements, and temporary generation or supply arrangements adopted to maintain supply to customers during maintenance or construction work, where otherwise supply would be interrupted.

3.16**planning level**

level of a particular disturbance in a particular environment, adopted as a reference value for the limits to be set for the emissions from the installations in a particular system, in order to co-ordinate those limits with all the limits adopted for equipment and installations intended to be connected to the power supply system

NOTE Planning levels are considered internal quality objectives to be specified at a local level by those responsible for planning and operating the power supply system in the relevant area.

3.17**point of common coupling (PCC)**

point in the public supply system, which is electrically closest to the installation concerned, at which other installations are, or could be, connected. The PCC is a point located upstream of the considered installation

NOTE A supply system is considered as being public in relation to its use, and not its ownership.

3.18**point of connection (POC)**

point on a public power supply system where the installation under consideration is, or can be connected

NOTE A supply system is considered as being public in relation to its use, and not its ownership.

3.19**point of evaluation (POE)**

point on a public power supply system where the emission levels of a given installation are to be assessed against the emission limits. This point can be the point of common coupling (PCC) or the point of connection (POC) or any other point specified by the system operator or owner or agreed upon

NOTE A supply system is considered as being public in relation to its use, and not its ownership.

3.20**short circuit power**

a theoretical value expressed in MVA of the initial symmetrical three-phase short-circuit power at a point on the supply system. It is defined as the product of the initial symmetrical short-circuit current, the nominal system voltage and the factor $\sqrt{3}$ with the aperiodic component (DC) being neglected

3.21**spur**

a feeder branch off a main feeder (typically applied on MV and LV feeders)

3.22**supply system**

all the lines, switchgear and transformers operating at various voltages which make up the transmission systems and distribution systems to which customers' installations are connected

3.23**system operator or owner**

the entity responsible for making technical connection agreements with customers who are seeking connection of load or generation to a distribution or transmission system

3.24**transfer coefficient (influence coefficient)**

the relative level of disturbance that can be transferred between two busbars or two parts of a power system for various operating conditions

3.25**voltage unbalance (imbalance)**

in a polyphase system, a condition in which the magnitudes of the phase voltages or the phase angles between consecutive phases are not all equal (fundamental component) [IEV 161-08-09 modified]

NOTE In three phase systems, the degree of the inequality is usually expressed as the ratio of the negative and zero sequence components to the positive sequence component. In this technical report, voltage unbalance is considered in relation to three-phase systems and negative sequence only.

3.26**phenomena related definitions**

the definitions below that relate to harmonics are based on the analysis of system voltages or currents by the Discrete Fourier Transform method (DFT). This is the practical application of the Fourier transform as defined in IEC 101-13-09 [28]

NOTE 1 The Fourier Transform of a function of time, whether periodic or non-periodic, is a function in the frequency domain and is referred to as the frequency spectrum of the time function, or simply spectrum. If the time function is periodic the spectrum is constituted of discrete lines (or components). If the time function is not periodic, the spectrum is a continuous function, indicating components at all frequencies.

NOTE 2 For simplicity the definitions given in this report refer only to (inter)harmonic components, however, these should not be interpreted as a restriction on the use of other definitions given in other IEC documents, for example, IEC 61000-4-7 [11] where the reference to (inter)harmonic groups or subgroups are more appropriate for measuring rapidly varying signals.

3.26.1**fundamental frequency**

frequency in the spectrum obtained from a Fourier transform of a time function, to which all the frequencies of the spectrum are referred. For the purpose of this technical report, the fundamental frequency is the same as the power supply frequency

NOTE In the case of a periodic function, the fundamental frequency is generally equal to the frequency corresponding to the period of the function itself.

3.26.2**fundamental component**

component whose frequency is the fundamental frequency

3.26.3**harmonic frequency**

frequency which is an integer multiple of the fundamental frequency. The ratio of the harmonic frequency to the fundamental frequency is the harmonic order (recommended notation: “h”)

3.26.4**harmonic component**

any of the components having a harmonic frequency. For brevity, such a component may be referred to simply as a harmonic

3.26.5**interharmonic frequency**

any frequency which is not an integer multiple of the fundamental frequency

NOTE 1 By extension from harmonic order, the interharmonic order is the ratio of an interharmonic frequency to the fundamental frequency. This ratio is not an integer. (Recommended notation “m”).

NOTE 2 In the case where $m < 1$ the term subharmonic frequency may be used.

3.26.6**interharmonic component**

component having an interharmonic frequency. For brevity, such a component may be referred to simply as an “interharmonic”

3.26.7**total harmonic distortion – THD**

ratio of the r.m.s. value of the sum of all the harmonic components up to a specified order (H) to the r.m.s. value of the fundamental component

iTech STANDARD PREVIEW
(standards.iteh.ai)

SIST-TP IEC/TR 61000-3-6:2016
<https://standards.iteh.ai/catalog/standards/sist/2653ba2c-86ea-49bc-a265-bf0d68e4151d/sist-tp-iec-tr-61000-3-6-2016>

$$THD = \sqrt{\sum_{h=2}^H \left(\frac{Q_h}{Q_1} \right)^2}$$

where

Q represents either current or voltage,

Q_1 is the r.m.s. value of the fundamental component,

h is the harmonic order,

Q_h is the r.m.s. value of the harmonic component of order h,

H is generally 40 or 50 depending on the application.

4 Basic EMC concepts related to harmonic distortion

The development of emission limits (voltage or current) for individual equipment or a customer's installation should be based on the effect that these emission limits will have on the quality of the voltage. Some basic concepts are used to evaluate voltage quality. In order for these concepts to be used for evaluation at specific locations, they are defined in terms of where they apply (locations), how they are measured (measurement duration, sample times, averaging durations, statistics), and how they are calculated. These concepts are described hereafter and illustrated in Figures 1 and 2. Definitions may be found in IEC 60050(161).

4.1 Compatibility levels

These are reference values (see Table 1) for co-ordinating the emission and immunity of equipment which is part of, or supplied by, a supply system in order to ensure the EMC in the whole system (including system and connected equipment). Compatibility levels are generally based on the 95 % probability levels of entire systems, using statistical distributions which represent both time and space variations of disturbances. There is allowance for the fact that